Single low-ohmic 8-channel analog switch

Rev. 5 — 3 July 2012

Product data sheet

1. General description

The NX3L4051 is a low-ohmic 8-channel analog switch, suitable for use as an analog or digital multiplexer/demultiplexer. The NX3L4051 has three digital select inputs (S1 to S3), eight independent inputs/outputs (Y0 to Y7) and a common input/output (Z). All eight switches share an enable input (\overline{E}). A HIGH on \overline{E} causes all switches into the high impedance OFF-state, independent of Sn.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I_{CC}. This makes it possible for the NX3L4051 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L4051 allows signals with amplitude up to V_{CC} to be transmitted from Z to Yn or from Yn to Z. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 1.7 Ω (typical) at V_{CC} = 1.4 V
 - 1.0 Ω (typical) at V_{CC} = 1.65 V
 - 0.6 Ω (typical) at V_{CC} = 2.3 V
 - 0.5 Ω (typical) at V_{CC} = 2.7 V
 - 0.5 Ω (typical) at V_{CC} = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
 - ◆ HBM JESD22-A114F Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - ◆ IEC61000-4-2 contact discharge exceeds 8000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78B Class II Level A
- 1.8 V control logic at V_{CC} = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V_{CC}
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



Single low-ohmic 8-channel analog switch

3. Applications

- Cell phone
- PDA
- Portable media player
- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

4. Ordering information

 Table 1.
 Ordering information

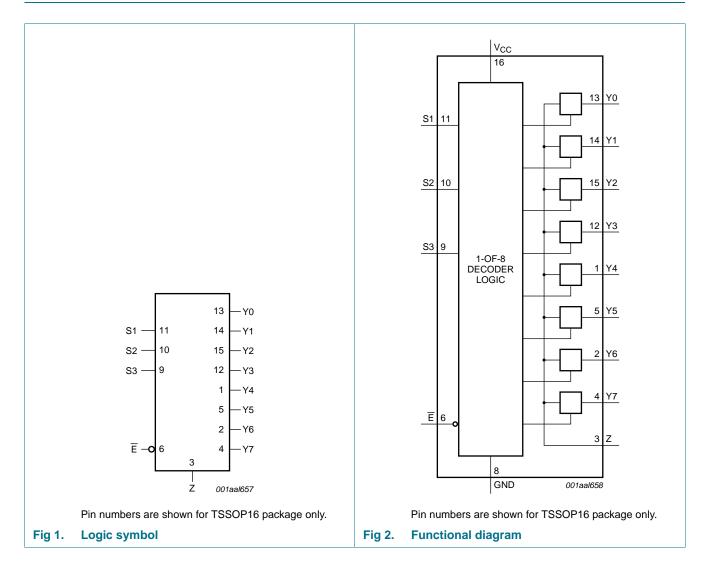
Type number	Package			
	Temperature range	Name	Description	Version
NX3L4051HR	–40 °C to +125 °C	HXQFN16	plastic thermal enhanced extremely thin quad flat package; no leads; 16 terminals; body $3 \times 3 \times 0.5$ mm	SOT1039-2
NX3L4051PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

5. Marking

Table 2. Marking codes	
Type number	Marking code
NX3L4051HR	M41
NX3L4051PW	X3L4051

Single low-ohmic 8-channel analog switch

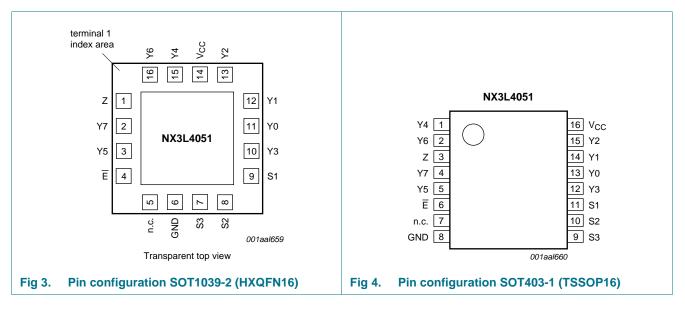
6. Functional diagram



Single low-ohmic 8-channel analog switch

Pinning information 7.

7.1 Pinning



7.2 Pin description

Symbol	Pin		Description	
	SOT1039-2	SOT403-1		
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	11, 12, 13, 10, 15, 3, 16, 2	13, 14, 15, 12, 1, 5, 2, 4	independent input or output	
Z	1	3	independent output or input	
Ē	4	6	enable input (active LOW)	
n.c.	5	7	not connected	
GND	6	8	ground (0 V)	
S1, S2, S3	9, 8, 7	11, 10, 9	select input	
V _{CC}	14	16	supply voltage	

8. Functional description

Table 4.	Function table ^[1]			
Input		Channel ON		
E	S3	S2	S1	
L	L	L	L	Y0 = Z
L	L	L	Н	Y1 = Z
L	L	Н	L	Y2 = Z
L	L	Н	Н	Y3 = Z
L	Н	L	L	Y4 = Z
L	Н	L	Н	Y5 = Z
L	Н	Н	L	Y6 = Z
L	Н	Н	Н	Y7 = Z
Н	Х	Х	Х	switches off

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	Sn and E	<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage		2 -0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±50	mA
I _{SW}	switch current	V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current	-	±350	mA
		V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$			
		HXQFN16	[3] _	250	mW
		TSSOP16	<u>[4]</u>	500	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For HXQFN16 package: above 135 °C the value of P_{tot} derates linearly with 16.9 mW/K.

[4] For TSSOP16 package: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K above.

10. Recommended operating conditions

Table 6.	Recommended operating conditions							
Symbol	Parameter	Conditions	Min	Max	Unit			
V _{CC}	supply voltage		1.4	4.3	V			
VI	input voltage	Sn and E	0	4.3	V			
V _{SW}	switch voltage		<u>[1]</u> 0	V _{CC}	V			
T _{amb}	ambient temperature		-40	+125	°C			
$\Delta t / \Delta V$	input transition rise and fall rate	Sn and \overline{E} ; V _{CC} = 1.4 V to 4.3 V	-	200	ns/V			

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} = -40 °C to +125 °C			Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V _{IH}	HIGH-level	$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	0.9	-	-	0.9	-	-	V
	input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	0.9	-	-	0.9	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	1.3	-	-	1.3	-	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	1.4	-	-	1.4	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	-	0.3	-	0.3	0.3	V
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	0.4	-	0.4	0.3	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.5	-	0.5	0.5	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	0.6	-	0.6	0.6	V
I	input leakage current	Sn and \overline{E} ; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μΑ
I _{S(OFF)}	OFF-state	Yn ports; see <u>Figure 5</u>							
	leakage	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nA
	current	$V_{CC} = 3.6 V \text{ to } 4.3 V$	-	-	±10	-	±50	±500	nA
I _{S(ON)}	ON-state leakage current	Z port; $V_{CC} = 1.4 V \text{ to } 3.6 V;$ see <u>Figure 6</u>							
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±20	-	±200	±2000	nA
		$V_{CC} = 3.6 V \text{ to } 4.3 V$	-	-	±40	-	±200	±2000	nA
I _{CC}	supply current								
		$V_{CC} = 3.6 V$	-	-	100	-	500	5000	nA
		$V_{CC} = 4.3 V$	-	-	150	-	800	6000	nA
NX3L4051		All information provided in this d	ocument is subje	ct to legal discl	aimers.		© NXP	B.V. 2012. All righ	ts reserve

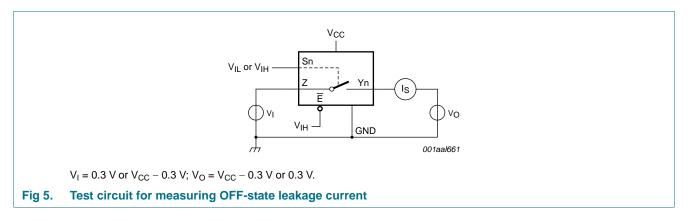
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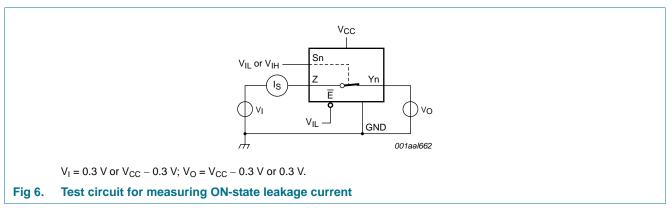
Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} =	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	_
ΔI_{CC}	additional	$V_{SW} = GND \text{ or } V_{CC}$							
	supply current	$V_1 = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μA
		$V_{I} = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	0.35	0.7	-	1	1	μΑ
		$V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	7.0	10.0	-	15	15	μΑ
		V _I = 1.8 V; V _{CC} = 3.6 V	-	2.5	4.0	-	5	5	μΑ
		$V_{I} = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$	-	50	200	-	300	500	nA
CI	input capacitance	Sn and \overline{E}	-	1.0	-	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	35	-	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance		-	350	-	-	-	-	pF

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

11.1 Test circuits





11.2 ON resistance

Table 8. ON resistance^[1]

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 14.

Symbol	Parameter	Conditions	T _{amb} =	-40 °C to	o +85 °C	$T_{amb} = -40$ °	°C to +125 °C	Unit
			Min	Typ ^[2]	Max	Min	Max	
R _{ON(peak)}	ON resistance (peak)	$V_I = GND$ to V_{CC} ; $I_{SW} = 100$ mA; see Figure 7						
		$V_{CC} = 1.4 V$	-	1.7	3.7	-	4.1	Ω
		V _{CC} = 1.65 V	-	1.0	1.6	-	1.7	Ω
		$V_{CC} = 2.3 V$	-	0.6	0.8	-	0.9	Ω
		$V_{CC} = 2.7 V$	-	0.5	0.75	-	0.9	Ω
		$V_{CC} = 4.3 V$	-	0.5	0.75	-	0.9	Ω
ΔR_{ON}	ON resistance mismatch	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	3]					
	between channels	V_{CC} = 1.4 V; V_{SW} = 0.4 V	-	0.18	0.30	-	0.30	Ω
	Channels	V_{CC} = 1.65 V; V_{SW} = 0.5 V	-	0.18	0.20	-	0.30	Ω
		V_{CC} = 2.3 V; V_{SW} = 0.7 V	-	0.07	0.10	-	0.13	Ω
		$V_{CC} = 2.7 \text{ V}; V_{SW} = 0.8 \text{ V}$	-	0.07	0.10	-	0.13	Ω
		V_{CC} = 4.3 V; V_{SW} = 0.8 V	-	0.07	0.10	-	0.13	Ω
R _{ON(flat)}	ON resistance (flatness)	$V_{I} = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	[4]					
		$V_{CC} = 1.4 V$	-	1.0	3.3	-	3.6	Ω
		V _{CC} = 1.65 V	-	0.5	1.2	-	1.3	Ω
		$V_{CC} = 2.3 V$	-	0.15	0.3	-	0.35	Ω
		$V_{CC} = 2.7 V$	-	0.13	0.3	-	0.35	Ω
		$V_{CC} = 4.3 V$	-	0.2	0.4	-	0.45	Ω

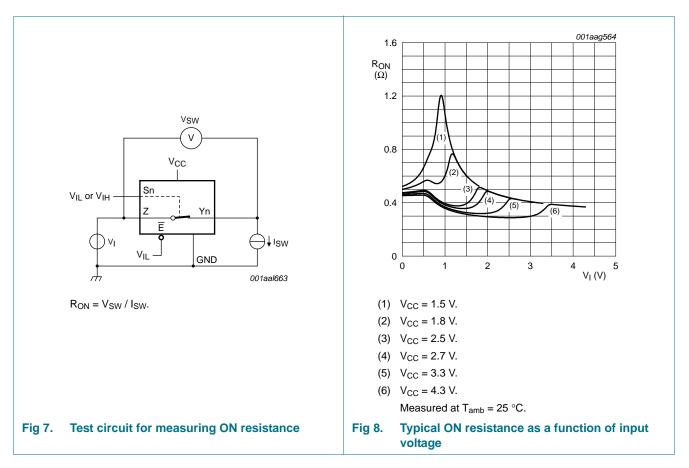
[1] For NX3L4051PW (TSSOP16 package), all ON resistance values are up to 0.05 Ω higher.

[2] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[3] Measured at identical V_{CC}, temperature and input voltage.

[4] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

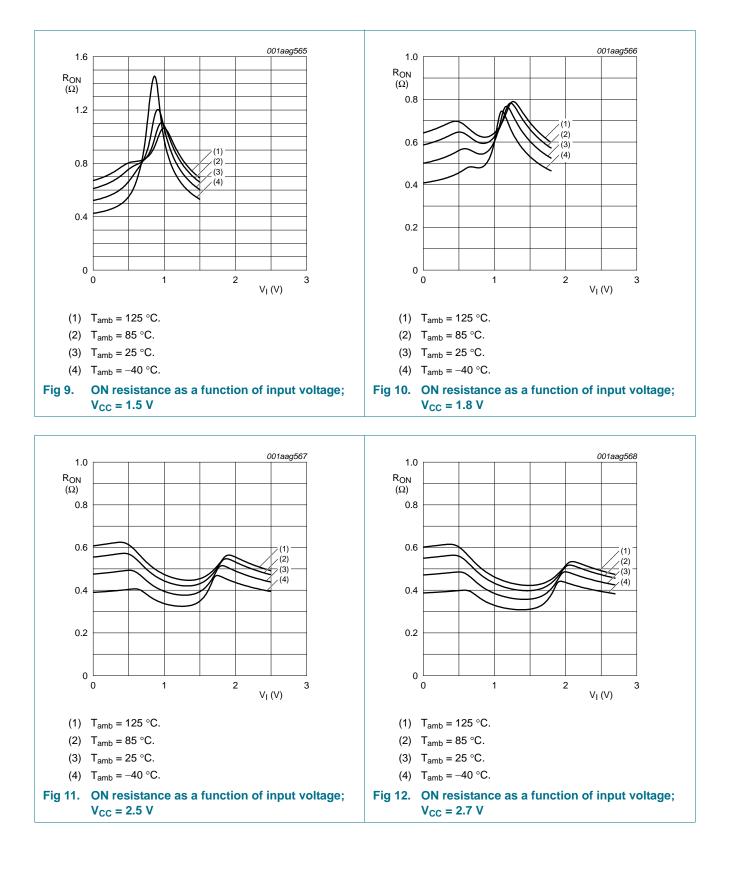
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11.3 ON resistance test circuit and graphs

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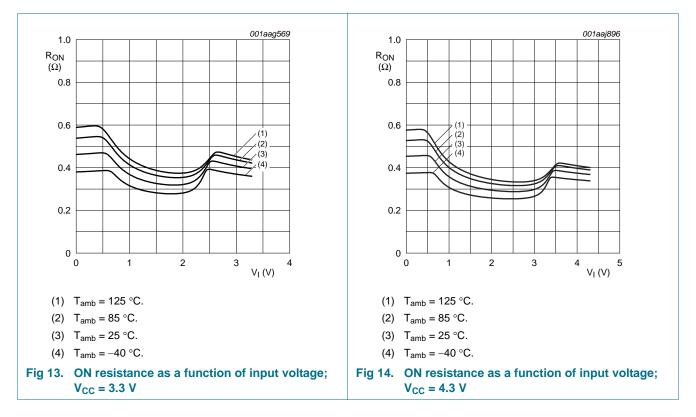
Single low-ohmic 8-channel analog switch



NX3L4051 Product data sheet

NX3L4051

Single low-ohmic 8-channel analog switch



12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} =	–40 °C to	+125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	
t _{en}	enable time	Ē, Sn to Z or Yn; see <u>Figure 15</u>							
		V_{CC} = 1.4 V to 1.6 V	-	45	100	-	120	125	ns
		V_{CC} = 1.65 V to 1.95 V	-	32	75	-	85	95	ns
		V_{CC} = 2.3 V to 2.7 V	-	21	50	-	55	60	ns
		V_{CC} = 2.7 V to 3.6 V	-	19	45	-	45	50	ns
		V_{CC} = 3.6 V to 4.3 V	-	19	45	-	45	50	ns
t _{dis}	disable time	Ē, Sn to Z or Yn; see <u>Figure 15</u>							
		V_{CC} = 1.4 V to 1.6 V	-	25	80	-	90	105	ns
		V_{CC} = 1.65 V to 1.95 V	-	15	65	-	70	75	ns
		V_{CC} = 2.3 V to 2.7 V	-	9	30	-	35	40	ns
		V_{CC} = 2.7 V to 3.6 V	-	8	25	-	30	35	ns
		V_{CC} = 3.6 V to 4.3 V	-	8	25	-	30	35	ns

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Symbol	Parameter	Conditions		T _{amb} = 25 °C		T _{amb} =	–40 °C to	+125 °C	Unit	
				Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
t _{b-m}	break-before-make	see Figure 16	[2]					•		
	time	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		-	19	-	9	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		-	17	-	7	-	-	ns
		V_{CC} = 2.3 V to 2.7 V		-	12	-	4	-	-	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		-	10	-	3	-	-	ns
		$V_{CC} = 3.6 \text{ V} \text{ to } 4.3 \text{ V}$		-	9	-	2	-	-	ns

Table 9. Dynamic characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

12.1 Waveform and test circuits

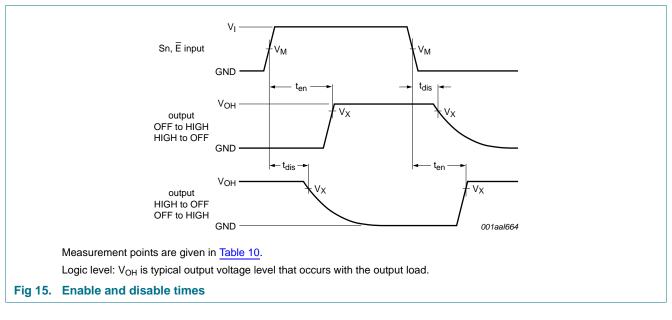


Table 10. Measurement points

Supply voltage	Input	Output
V _{cc}	V _M	V _X
1.4 V to 4.3 V	0.5V _{CC}	0.9V _{OH}

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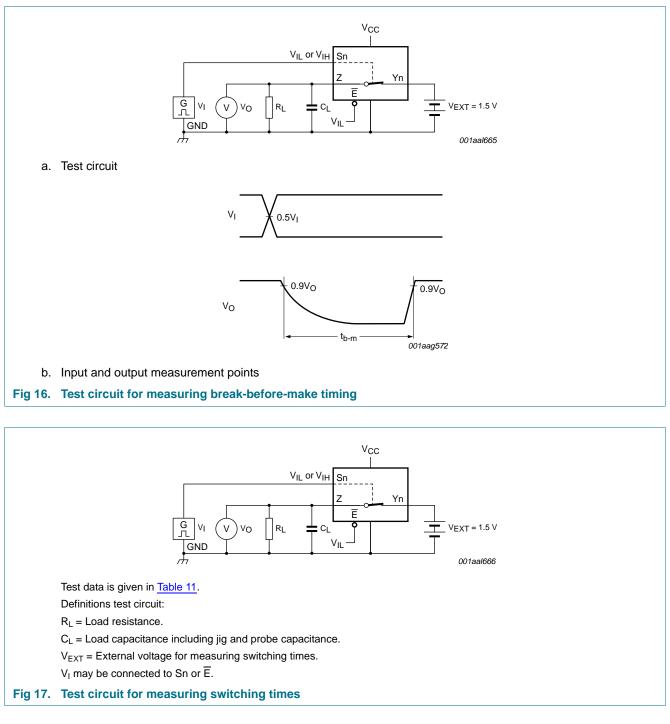


Table 11. Test data

Supply voltage	Input		Load	
V _{cc}	VI	t _r , t _f	CL	R _L
1.4 V to 4.3 V	V _{CC}	≤ 2.5 ns	35 pF	50 Ω

12.2 Additional dynamic characteristics

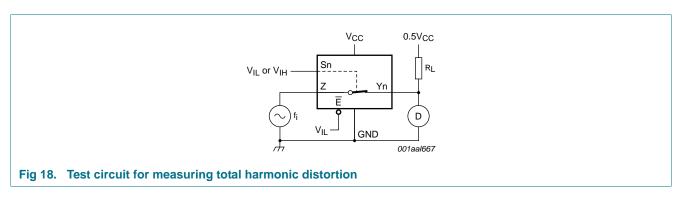
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns; $T_{amb} = 25$ °C.

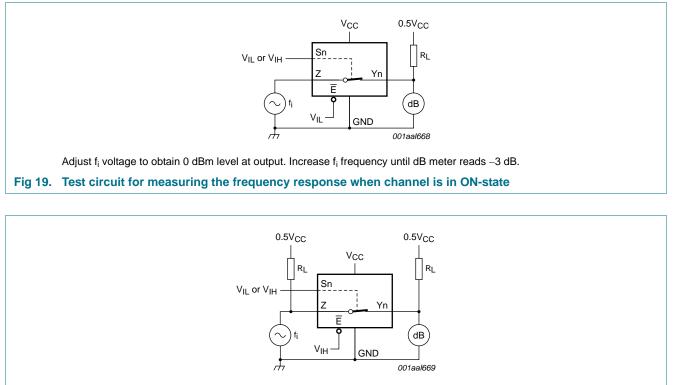
Symbol	Parameter	Conditions	Mi	n Typ	Max	Unit
THD	total harmonic distortion	$f_i = 20 \text{ Hz to } 20 \text{ kHz}; \text{ R}_L = 32 \Omega; \text{ see } \frac{\text{Figure } 18}{1000 \text{ sec}}$	<u>[1]</u>			
		V _{CC} = 1.4 V; V _I = 1 V (p-p)		- 0.15	-	%
		V _{CC} = 1.65 V; V _I = 1.2 V (p-p)		- 0.10	-	%
		V _{CC} = 2.3 V; V _I = 1.5 V (p-p)		- 0.02	-	%
		V _{CC} = 2.7 V; V _I = 2 V (p-p)		- 0.02	-	%
		V _{CC} = 4.3 V; V _I = 2 V (p-p)		- 0.02	-	%
f _(-3dB)	-3 dB frequency	$R_L = 50 \Omega$; see Figure 19	[1]			
· · /	response	$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$		- 15	-	MHz
α_{iso}	isolation (OFF-state)	$f_i = 100 \text{ kHz}; R_L = 50 \Omega; \text{ see } \frac{\text{Figure 20}}{100 \text{ kHz}}$	[1]			
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$		- –90	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 50 \Omega$; see Figure 21				
		V _{CC} = 1.4 V to 3.6 V		- 0.2	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$		- 0.3	-	V
Xtalk	crosstalk	between switches; $f_i = 100 \text{ kHz}$; $R_L = 50 \Omega$; see Figure 22	[1]			
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$		- –90	-	dB
Q _{inj}	charge injection	f_i = 1 MHz; C _L = 0.1 nF; R _L = 1 MΩ; V _{gen} = 0 V; R _{gen} = 0 Ω; see <u>Figure 23</u>				
		V _{CC} = 1.5 V		- 3	-	рС
		V _{CC} = 1.8 V		- 4	-	рС
		$V_{CC} = 2.5 V$		- 6	-	рС
		V _{CC} = 3.3 V		- 9	-	рС
		$V_{CC} = 4.3 V$		- 15	-	рС

[1] f_i is biased at 0.5V_{CC}.

12.3 Test circuits



Single low-ohmic 8-channel analog switch

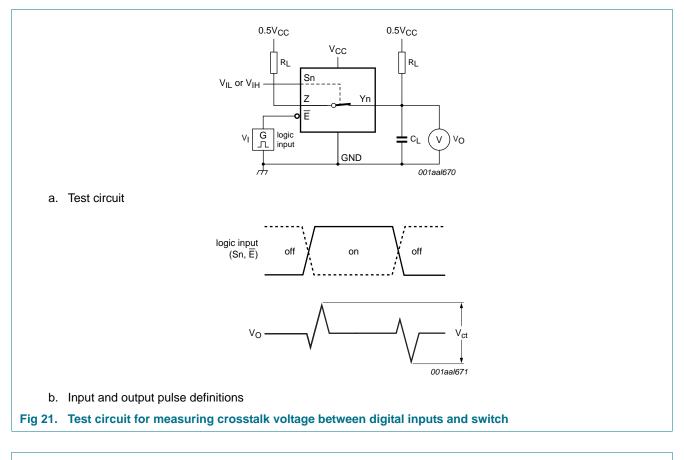


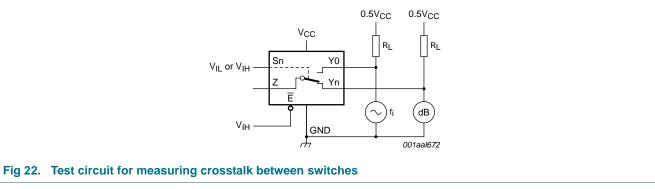
Adjust f_i voltage to obtain 0 dBm level at input.

Fig 20. Test circuit for measuring isolation (OFF-state)

NX3L4051

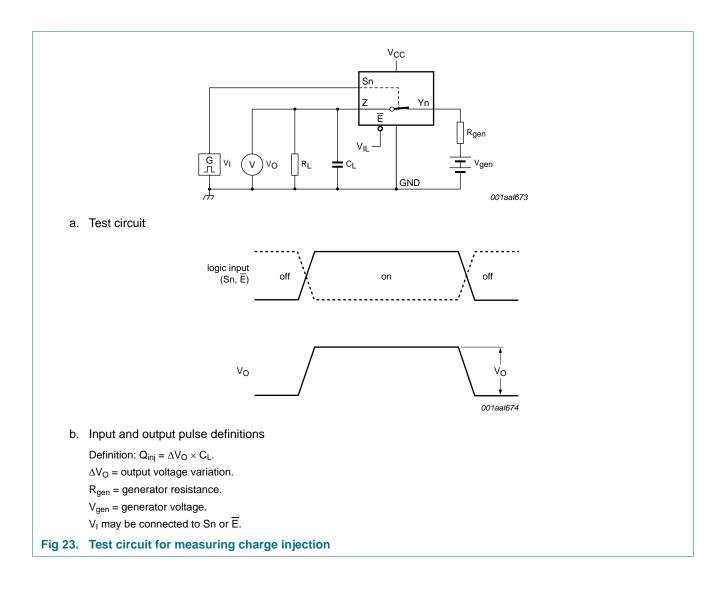
Single low-ohmic 8-channel analog switch





NX3L4051

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NX3L4051

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13. Package outline

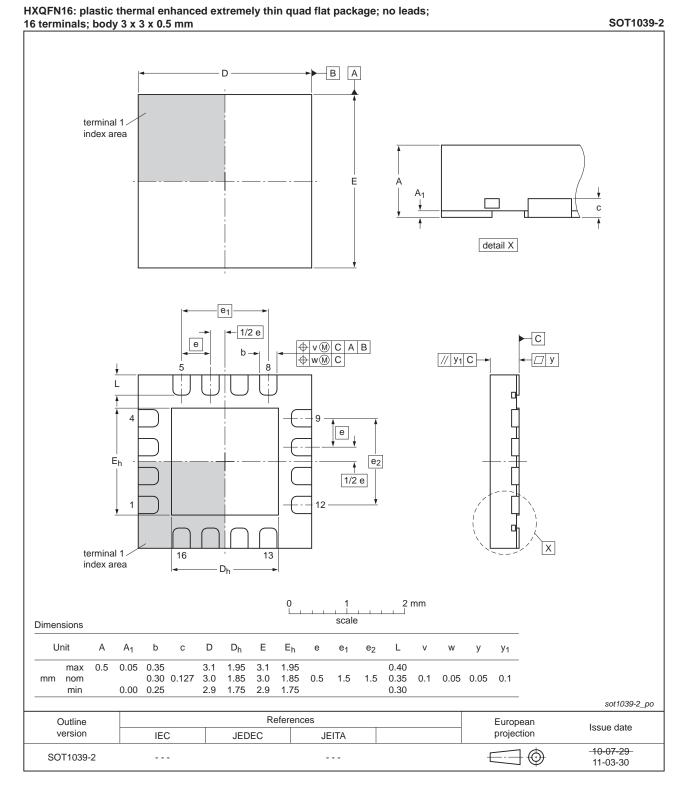


Fig 24. Package outline SOT1039-2 (HXQFN16)

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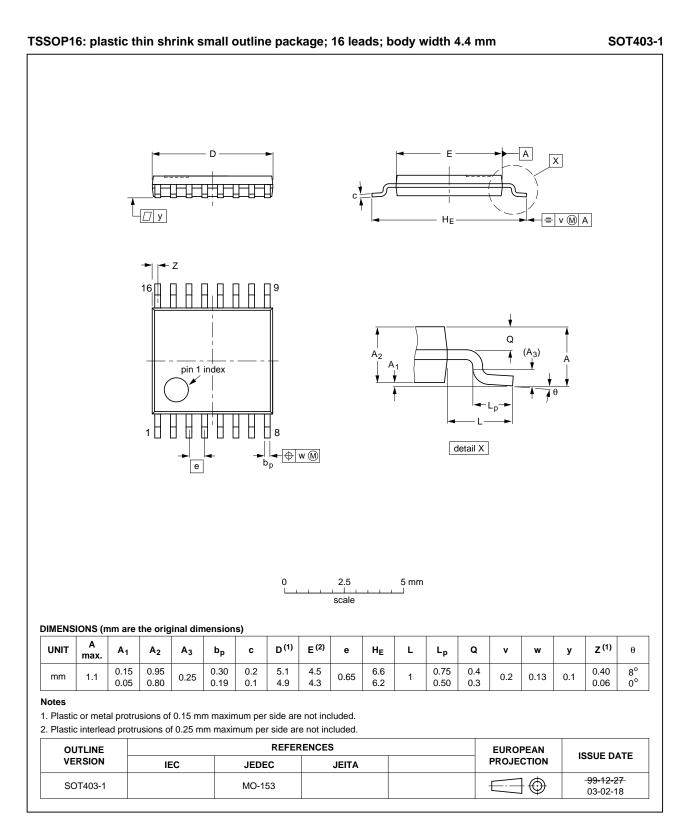


Fig 25. Package outline SOT403-1 (TSSOP16)

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14. Abbreviations

Table 13. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal-Oxide Semiconductor			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
PDA	Personal Digital Assistant			

15. Revision history

Table 14. Revision hist	tory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L4051 v.5	20120703	Product data sheet	-	NX3L4051 v.4
Modifications:	 For type num 	ber NX3L4051HR the sot cod	e has changed to SOT	1039-2.
NX3L4051 v.4	20111107	Product data sheet	-	NX3L4051 v.3
Modifications:	 Legal pages 	updated.		
NX3L4051 v.3	20101222	Product data sheet	-	NX3L4051 v.2
NX3L4051 v.2	20100812	Product data sheet	-	NX3L4051 v.1
NX3L4051 v.1	20100415	Product data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Single low-ohmic 8-channel analog switch

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